

# TLV2217-33, TLV2217-33Y LOW-DROPOUT 3.3-V FIXED-VOLTAGE REGULATORS

SLVS067F – MARCH 1992 – REVISED AUGUST 1998

- Fixed 3.3-V Output
- $\pm 1\%$  Maximum Output Voltage Tolerance at  $T_J = 25^\circ\text{C}$
- 500-mV Maximum Dropout Voltage at 500 mA
- 500-mA Dropout Current
- $\pm 2\%$  Absolute Output Voltage Variation
- Internal Overcurrent Limiting
- Internal Thermal-Overload Protection
- Internal Overvoltage Protection
- Package Options Include Plastic Flange Mounted (KTP), Power (KC), and Thin Shrink Small-Outline (PW) Packages, and Ceramic Chip Carriers (FK) and DIPs (J)

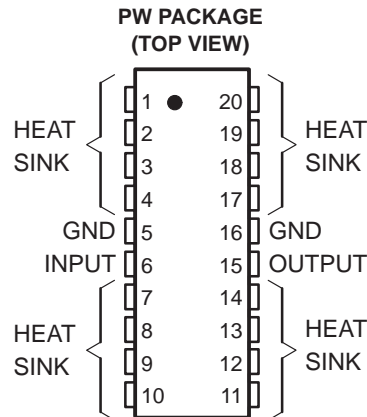
## description

The TLV2217-33 is a low-dropout 3.3-V fixed-voltage regulator. The regulator is capable of sourcing 500 mA of current with an input-output differential of 0.5 V or less. The TLV2217-33 provides internal overcurrent limiting, thermal-overload protection, and overvoltage protection.

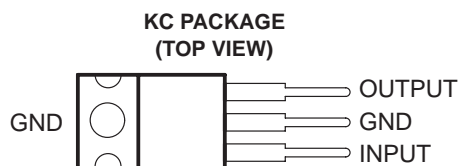
The 0.5-V dropout for the TLV2217-33 makes it ideal for battery applications in 3.3-V logic systems. For example, battery input voltage to the regulator can drop as low as 3.8 V, and the TLV2217-33 can continue to regulate the system. For higher voltage systems, the TLV2217-33 can be operated with a continuous input voltage of 12 V.

The TLV2217-33 regulators are characterized for operation from  $0^\circ\text{C}$  to  $125^\circ\text{C}$  virtual junction temperature.

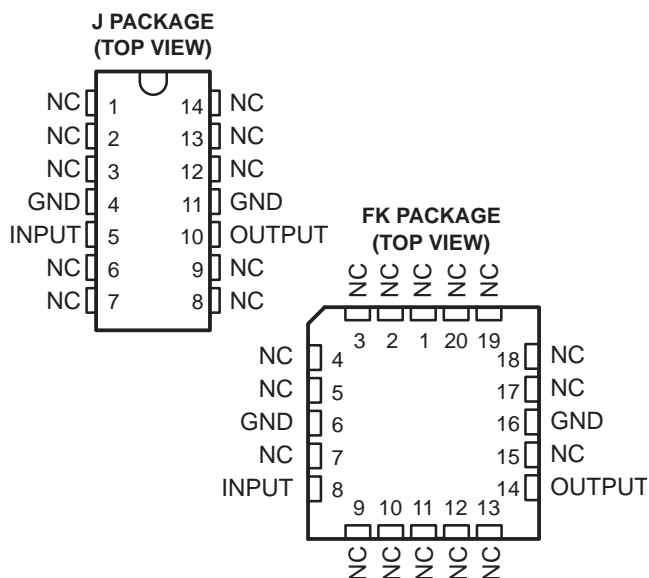
The TLV2217-33M regulators are characterized for operation over the full military virtual junction temperature range of  $-55^\circ\text{C}$  to  $125^\circ\text{C}$ .



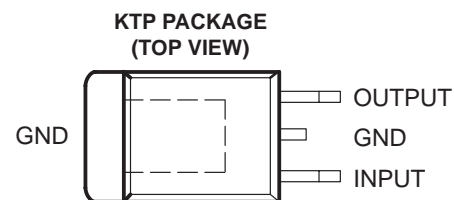
HEAT SINK – These terminals have an internal resistive connection to ground and should be grounded or electrically isolated.



The GND terminal is in electrical contact with the mounting base.



NC – No internal connection



The GND terminal is in electrical contact with the mounting base.



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

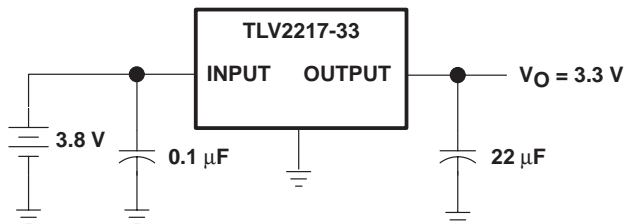
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# TLV2217-33, TLV2217-33Y LOW-DROPOUT 3.3-V FIXED-VOLTAGE REGULATORS

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## application schematic



### AVAILABLE OPTIONS

T <sub>J</sub>	PACKAGED DEVICES					CHIP FORM (Y)
	CHIP CARRIER (FK)	CERAMIC DIP (J)	PLASTIC POWER (KC)	SURFACE MOUNT (PW)†	PLASTIC FLANGE MOUNT (KTP)†	
0°C to 125°C	—	—	TLV2217-33KC	TLV2217-33PWR	TLV2217-33KTPR	TLV2217-33Y
-55°C to 125°C	TLV2217-33MFKB	TLV2217-33MJB	—	—	—	

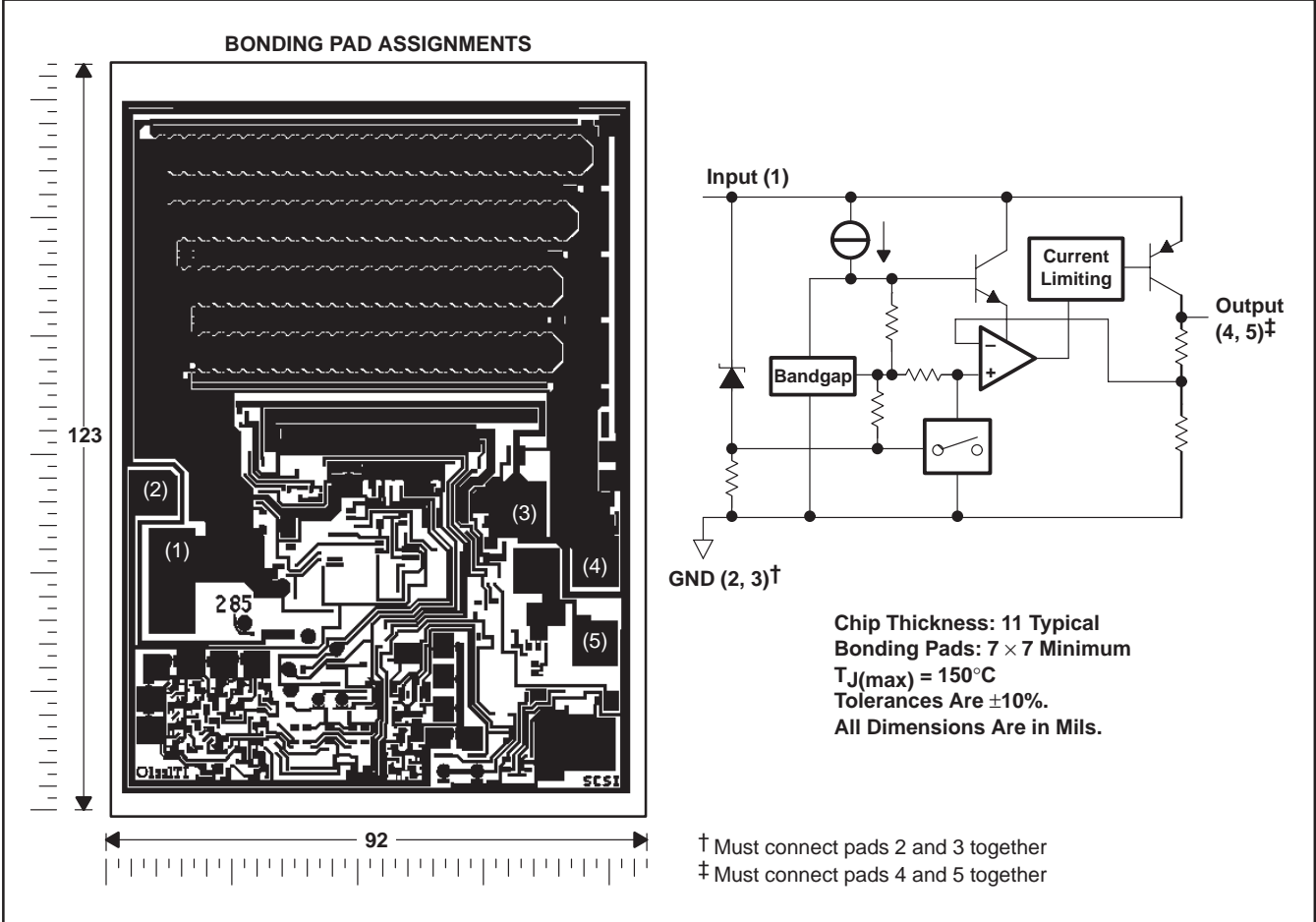
† The KTP and PW packages are available left-end taped and reeled only.

# TLV2217-33, TLV2217-33Y LOW-DROPOUT 3.3-V FIXED-VOLTAGE REGULATORS

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## TLV2217-33Y chip information

These chips, when properly assembled, display characteristics similar to the TLV2217-33 (see electrical tables). Thermal compression or ultrasonic bonding can be used on the doped aluminum bonding pads. The chip can be mounted with conductive epoxy or a gold-silicon preform.





# TLV2217-33, TLV2217-33Y LOW-DROPOUT 3.3-V FIXED-VOLTAGE REGULATORS

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## TLV2217-33 recommended operating conditions

	TLV2217-33		UNIT
	MIN	MAX	
Input voltage, $V_I$	3.8	12	V
Output current, $I_O$	0	500	mA
Operating virtual junction temperature range, $T_J$	0	125	°C

## TLV2217-33M recommended operating conditions

		TLV2217-33M		UNIT
		MIN	MAX	
Input voltage, $V_I$	$T_J = 25^\circ\text{C}$	3.8	12	V
	$T_J = -55^\circ\text{C}$ to $125^\circ\text{C}$	3.9	12	
Output current, $I_O$		0	480	mA
Operating virtual junction temperature range, $T_J$		-55	125	°C

## electrical characteristics at $V_I = 4.5\text{ V}$ , $I_O = 500\text{ mA}$ , $T_J = 25^\circ\text{C}$ (unless otherwise noted)

PARAMETER	TEST CONDITION <sup>†</sup>	TLV2217-33			UNIT	
		MIN	TYP	MAX		
Output voltage	$I_O = 20\text{ mA}$ to $500\text{ mA}$ , $V_I = 3.8\text{ V}$ to $5.5\text{ V}$	$T_J = 25^\circ\text{C}$	3.267	3.30	3.333	V
		$T_J = 0^\circ\text{C}$ to $125^\circ\text{C}$	3.234		3.366	
Input voltage regulation	$V_I = 3.8\text{ V}$ to $5.5\text{ V}$		5	15	mV	
Ripple rejection	$f = 120\text{ Hz}$ , $V_{\text{ripple}} = 1\text{ V}_{\text{PP}}$		-62		dB	
Output voltage regulation	$I_O = 20\text{ mA}$ to $500\text{ mA}$		5	30	mV	
Output noise voltage	$f = 10\text{ Hz}$ to $100\text{ kHz}$		500		$\mu\text{V}$	
Dropout voltage	$I_O = 250\text{ mA}$			400	mV	
	$I_O = 500\text{ mA}$			500		
Bias current	$I_O = 0$		2	5	mA	
	$I_O = 500\text{ mA}$		19	49		

<sup>†</sup> Pulse-testing techniques are used to maintain the virtual junction temperature as close to the ambient temperature as possible. Thermal effects must be taken into account separately. All characteristics are measured with a  $0.1\text{-}\mu\text{F}$  capacitor across the input and a  $22\text{-}\mu\text{F}$  tantalum capacitor with equivalent series resistance of  $1.5\ \Omega$  on the output.

# TLV2217-33, TLV2217-33Y

## LOW-DROPOUT 3.3-V FIXED-VOLTAGE REGULATORS

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### electrical characteristics at $V_I = 4.5\text{ V}$ , $I_O = 500\text{ mA}$ , $T_J = 25^\circ\text{C}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS†		TLV2217-33M			UNIT
			MIN	TYP	MAX	
Output voltage	$I_O = 20\text{ mA to }480\text{ mA}$	$V_I = 3.8\text{ V to }5.5\text{ V}, T_J = 25^\circ$	3.267	3.3	3.333	V
		$V_I = 3.9\text{ V to }5.5\text{ V}$	3.234		3.366	
Input voltage regulation	$V_I = 3.8\text{ V to }5.5\text{ V},$	$T_J = 25^\circ\text{C}$			15	mV
Ripple rejection	$f = 120\text{ Hz},$	$V_{\text{ripple}} = 1\text{ V}_{\text{PP}}$		-62		dB
Output voltage regulation	$I_O = 20\text{ mA to }480\text{ mA},$	$T_J = 25^\circ\text{C}$			30	mV
Output noise voltage	$f = 10\text{ Hz to }100\text{ kHz}$			500		$\mu\text{V}$
Dropout voltage	$I_O = 250\text{ mA}$				400	mV
	$I_O = 480\text{ mA},$	$T_J = 25^\circ\text{C}$			500	
	$I_O = 480\text{ mA}$				550	
Bias current	$I_O = 0$				5	mA
	$I_O = 480\text{ mA}$				49	

† Pulse-testing techniques are used to maintain the virtual junction temperature as close to the ambient temperature as possible. Thermal effects must be taken into account separately. All characteristics are measured with a 0.1- $\mu\text{F}$  capacitor across the input and a 22- $\mu\text{F}$  tantalum capacitor with equivalent series resistance of 1.5  $\Omega$  on the output.

### electrical characteristics at $V_I = 4.5\text{ V}$ , $I_O = 500\text{ mA}$ , $T_J = 25^\circ\text{C}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS†		TLV2217-33Y			UNIT
			MIN	TYP	MAX	
Output voltage	$I_O = 20\text{ mA to }500\text{ mA},$	$V_I = 3.8\text{ V to }5.5\text{ V}$	3.267	3.30	3.333	V
Input voltage regulation	$V_I = 3.8\text{ V to }5.5\text{ V}$			5	15	mV
Ripple rejection	$f = 120\text{ Hz},$	$V_{\text{ripple}} = 1\text{ V}_{\text{PP}}$		-62		dB
Output voltage regulation	$I_O = 20\text{ mA to }500\text{ mA}$			5	30	mV
Output noise voltage	$f = 10\text{ Hz to }100\text{ kHz}$			500		$\mu\text{V}$
Dropout voltage	$I_O = 250\text{ mA}$				400	mV
	$I_O = 500\text{ mA}$				500	
Bias current	$I_O = 0$			2	5	mA
	$I_O = 500\text{ mA}$			19	49	

† Pulse-testing techniques are used to maintain the virtual junction temperature as close to the ambient temperature as possible. Thermal effects must be taken into account separately. All characteristics are measured with a 0.1- $\mu\text{F}$  capacitor across the input and a 22- $\mu\text{F}$  tantalum capacitor with equivalent series resistance of 1.5  $\Omega$  on the output.



COMPENSATION CAPACITOR SELECTION INFORMATION

The TLV2217-33 is a low-dropout regulator. This means that the capacitance loading is important to the performance of the regulator because it is a vital part of the control loop. The capacitor value and the equivalent series resistance (ESR) both affect the control loop and must be defined for the load range and the temperature range. Figures 3 and 4 can be used to establish the capacitance value and ESR range for best regulator performance.

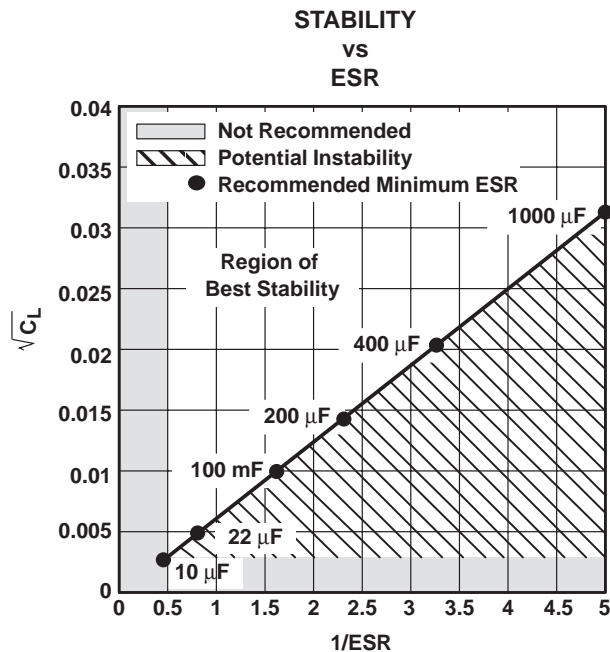
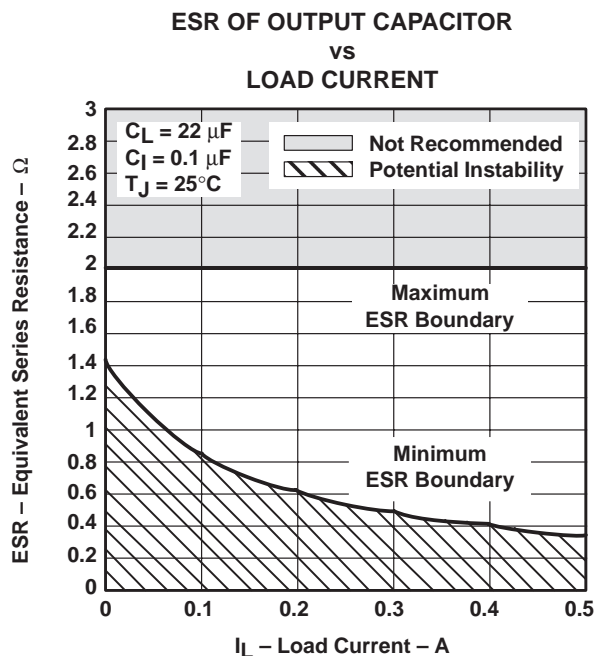


Figure 4

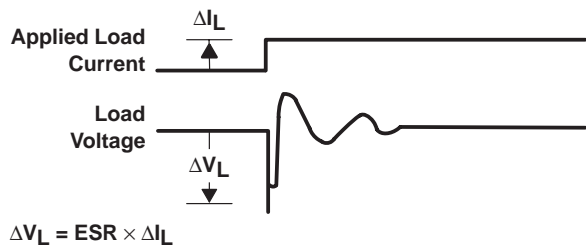


Figure 3

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